



**THE DATASHEET OF  
IS281GB**

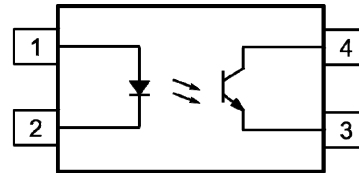




## DESCRIPTION

The IS281 series optocoupler consists of an infrared emitting diode optically coupled to an NPN silicon photo transistor.

This device belongs to Isocom Compact Range of Optocouplers.



1 Anode  
2 Cathode  
3 Emitter  
4 Collector

## FEATURES

- Half Pitch 1.27mm
- High AC Isolation voltage 3750V<sub>RMS</sub>
- CTR Selections Available
- Wide Operating Temperature Range -55°C to 110°C
- Pb Free and RoHS Compliant
- UL Approval E91231, Model "THP"

## APPLICATIONS

- Switching Mode Power Supply
- Industrial System Controllers
- Measuring Instruments
- Signal Transmission between Systems of Different Potentials and Impedances

## ORDER INFORMATION

- Available in Tape and Reel with 1000pcs per reel

## ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C)

Stresses exceeding the absolute maximum ratings can cause permanent damage to the device. Exposure to absolute maximum ratings for long periods of time can adversely affect reliability.

### Input

Forward Current	50mA
Reverse Voltage	6V
Power dissipation	70mW

### Output

Collector to Emitter Voltage BV <sub>CEO</sub>	80V
Emitter to Collector Voltage BV <sub>ECO</sub>	7V
Collector Current	50mA
Power Dissipation	150mW

### Total Package

Isolation Voltage	3750V <sub>RMS</sub>
Total Power Dissipation	200mW
Operating Temperature	-55 to 110 °C
Storage Temperature	-55 to 150 °C
Lead Soldering Temperature (10s)	260°C

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## IS281

### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise specified)

#### INPUT

Parameter	Symbol	Test Condition	Min	Typ.	Max	Unit
Forward Voltage	$V_F$	$I_F = 20\text{mA}$		1.2	1.4	V
Reverse Current	$I_R$	$V_R = 4\text{V}$			10	$\mu\text{A}$
Terminal Capacitance	$C_{IN}$	$V = 0\text{V}, f = 1\text{KHz}$		30	250	pF

#### OUTPUT

Parameter	Symbol	Test Condition	Min	Typ.	Max	Unit
Collector-Emitter Breakdown Voltage	$BV_{CEO}$	$I_C = 0.1\text{mA}, I_F = 0\text{mA}$	80			V
Emitter-Collector Breakdown Voltage	$BV_{ECO}$	$I_E = 0.1\text{mA}, I_F = 0\text{mA}$	7			V
Collector-Emitter Dark Current	$I_{CEO}$	$V_{CE} = 20\text{V}, I_F = 0\text{mA}$			100	nA

## IS281

### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise specified)

#### COUPLED

Parameter	Symbol	Test Condition	Min	Typ.	Max	Unit	
Current transfer ratio	CTR	$I_F = 5\text{mA}, V_{CE} = 5\text{V}$	IS281	50		600	%
			IS281A	80		160	
		IS281B	130		260		
		IS281C	200		400		
		IS281D	300		600		
		IS281E	100		200		
		IS281F	150		300		
		IS281GB	100		600		
		$I_F = 10\text{mA}, V_{CE} = 5\text{V}$	IS281H	40		80	
			IS281I	63		125	
			IS281J	100		200	
			IS281K	160		320	
			IS281GR	100		300	
			Collector-Emitter Saturation Voltage	$V_{CE(\text{sat})}$	$I_F = 10\text{mA}, I_C = 1\text{mA}$		
Floating Capacitance	$C_f$	$V_F = 0\text{V}, f = 1\text{MHz}$		0.3		pF	
Output Rise Time	$t_r$	$V_{CE} = 2\text{V}, I_C = 2\text{mA}, R_L = 100\Omega$		6	18	$\mu\text{s}$	
Output Fall Time	$t_f$	$V_{CE} = 2\text{V}, I_C = 2\text{mA}, R_L = 100\Omega$		6	18	$\mu\text{s}$	

#### ISOLATION

Parameter	Symbol	Test Condition	Min	Typ.	Max	Unit
Isolation Voltage	$V_{\text{ISO}}$	R.H. = 40% to 60%, $t = 1\text{ min}$ Note 1	3750			$V_{\text{RMS}}$
Input - Output Resistance	$R_{\text{I-O}}$	$V_{\text{I-O}} = 500\text{VDC}$ R.H. = 40% to 60% Note 1	$5 \times 10^{10}$			$\Omega$

Note 1 : Measured with input leads shorted together and output leads shorted together.

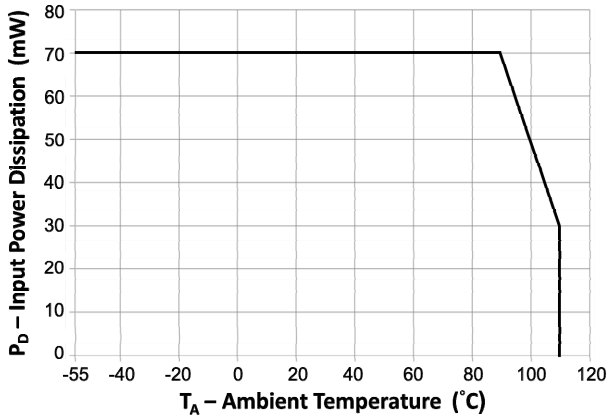


Fig 1 Input Power Dissipation vs Ambient Temperature

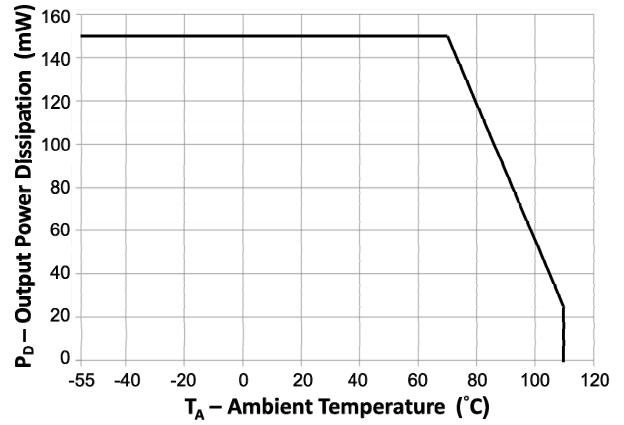


Fig 2 Output Power Dissipation vs Ambient Temperature

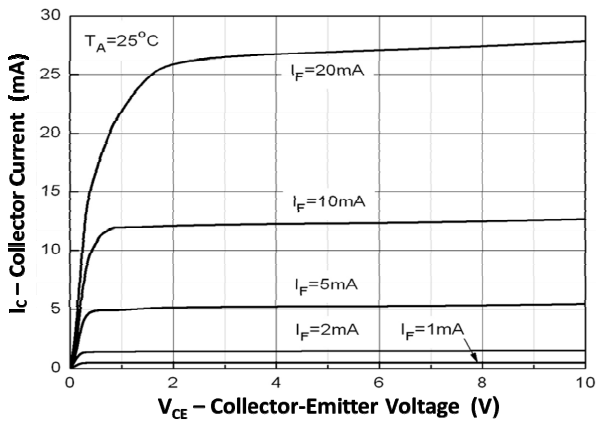


Fig 3 Collector Current vs Collector-Emitter Voltage (1)

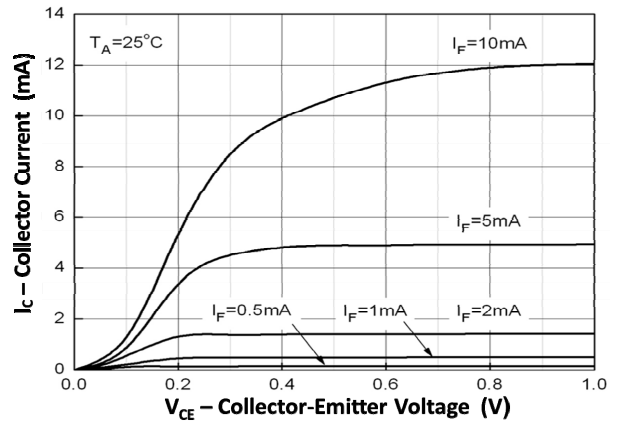


Fig 4 Collector Current vs Collector-Emitter Voltage (2)

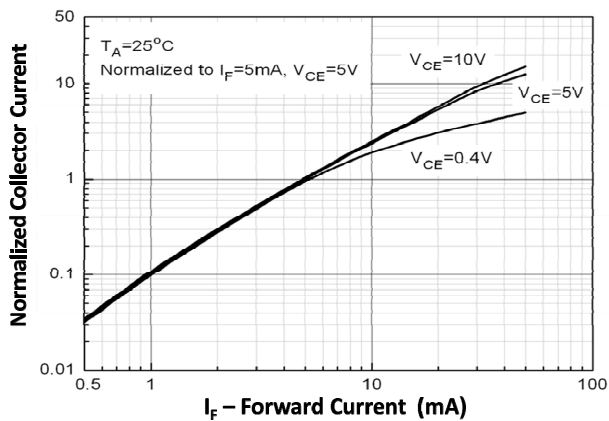


Fig 5 Normalized Collector Current vs Forward Voltage

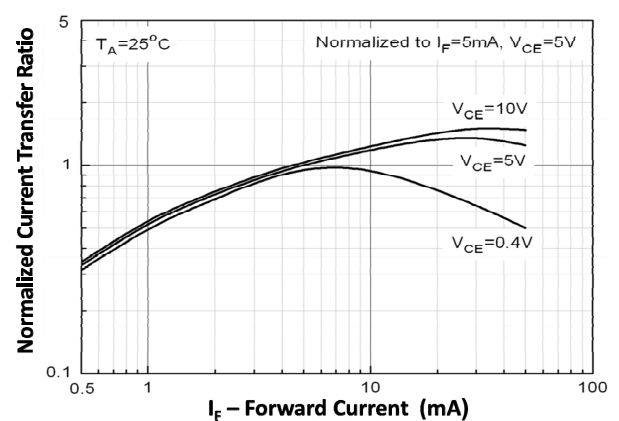


Fig 6 Collector Current Transfer Ratio vs Forward Current

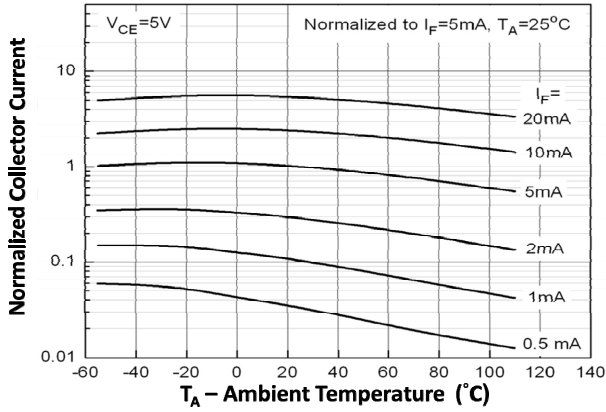


Fig 7 Normalized Collector Current vs Ambient Temperature

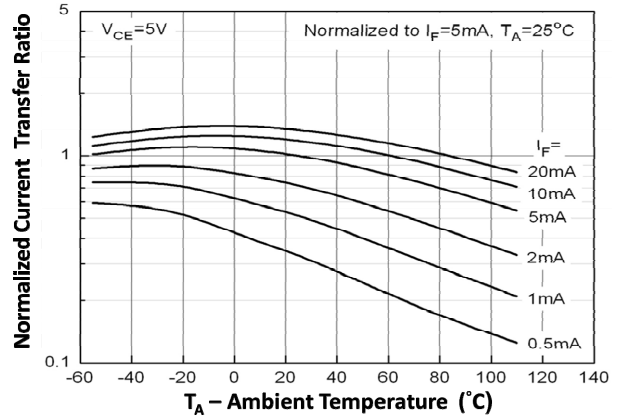


Fig 8 Normalized Current Transfer Ratio vs Ambient Temperature

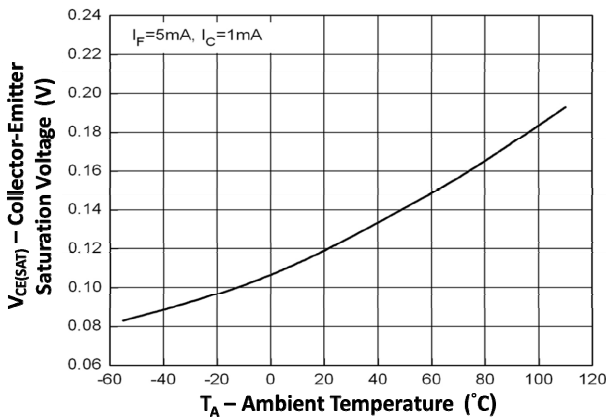


Fig 9 Collector-Emitter Voltage vs Ambient Temperature

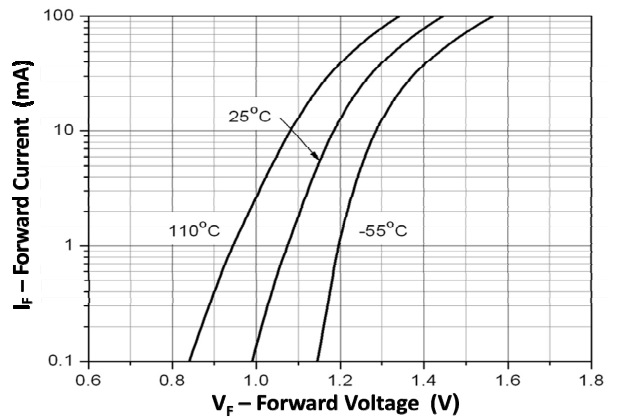


Fig 10 Forward Current vs Forward Voltage

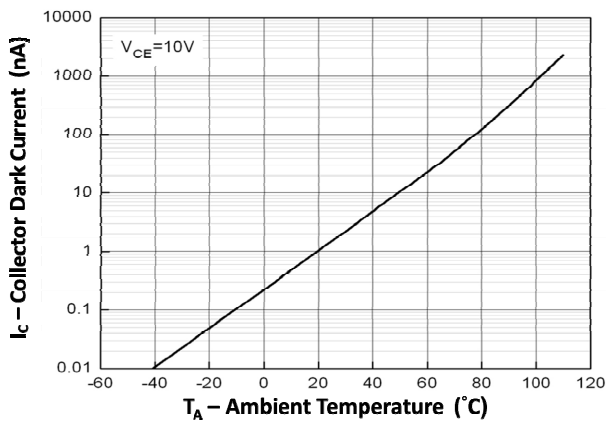


Fig 11 Collector Dark Current vs Ambient Temperature

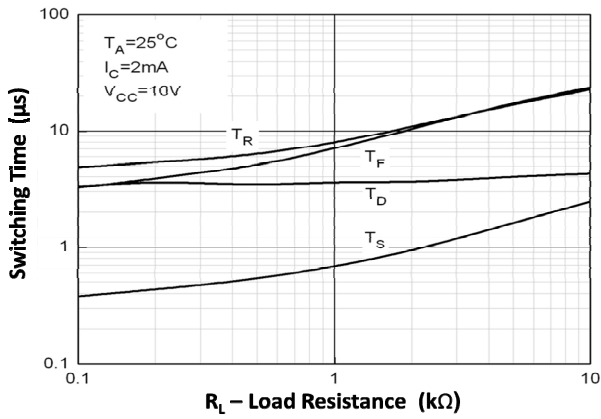
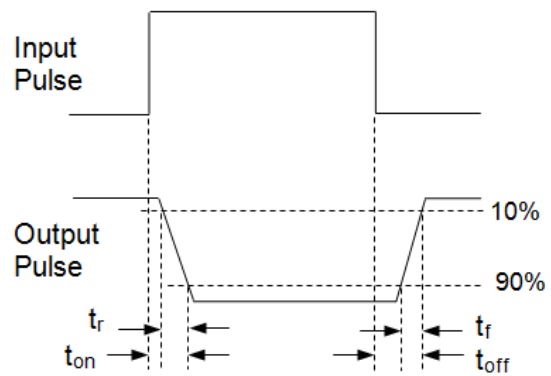
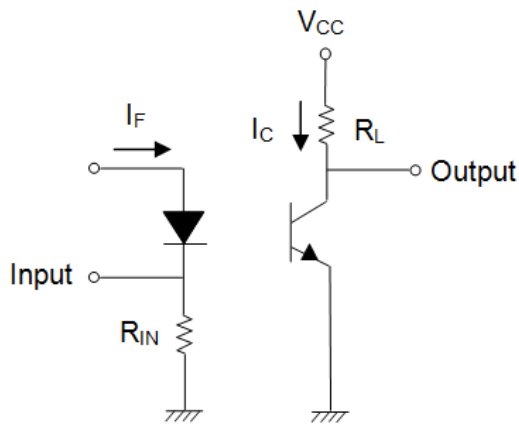


Fig 12 Switching Time vs Load Resistance



Switching Time Test Circuit

## IS281

### ORDER INFORMATION

IS281			
After PN	PN	Description	Packing quantity
None	IS281	Surface Mount Tape & Reel	1000 pcs per reel
Any CTR Grade	IS281A, IS281B, IS281C, IS281D, IS281E, IS281F, IS281H, IS281I, IS281J, IS281K, IS281GR, IS281GB	Surface Mount Tape & Reel	1000 pcs per reel

**NOTE : Multiple Grades may be supplied to meet the requested specification**

### DEVICE MARKING



THP\_ denotes Device Part Number where “\_” denotes CTR Grade

I denotes Isocom

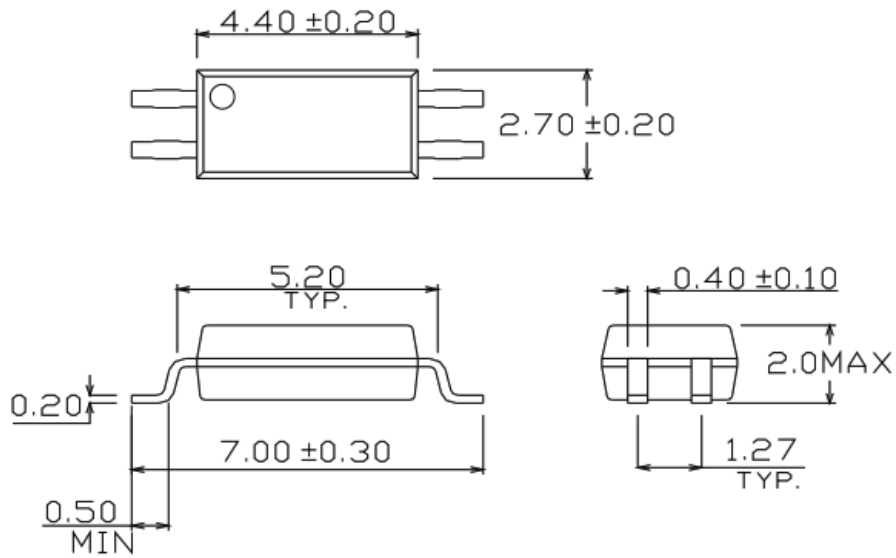
Y denotes 1 digit Year code

WW denotes 2 digit Week code

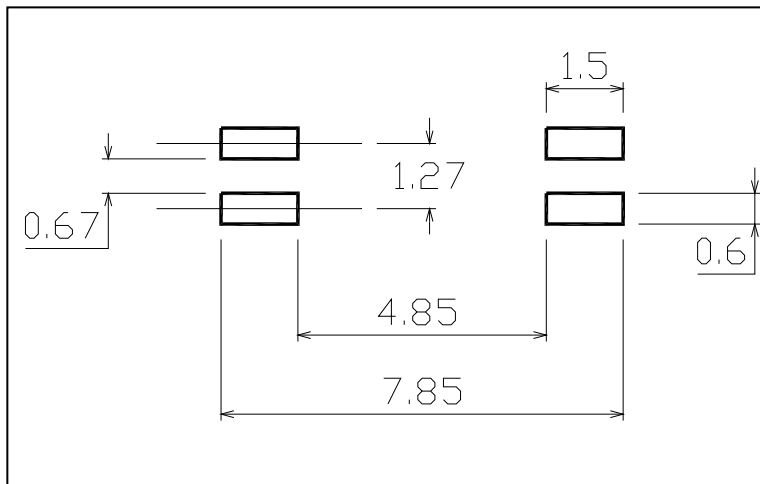
<b>Note :</b>	<b>Device</b>	<b>Optional Marking</b>
	IS281	THP1
	IS281B	THP3
	IS281F	THP10

# IS281

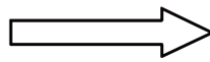
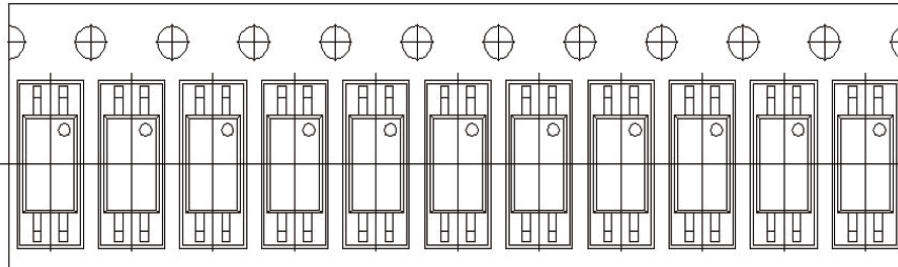
## PACKAGE DIMENSIONS (mm)



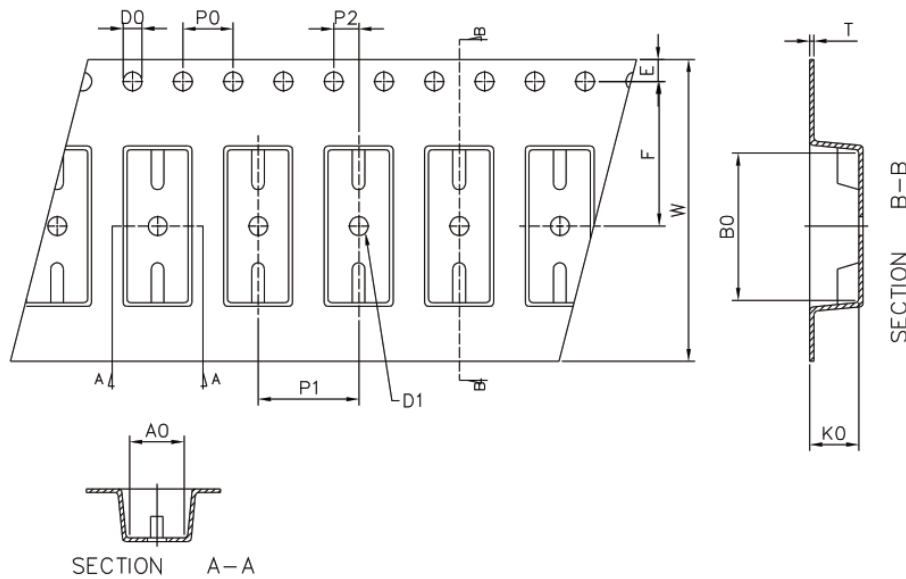
## RECOMMENDED SOLDER PAD LAYOUT (mm)



Tape and Reel Packaging



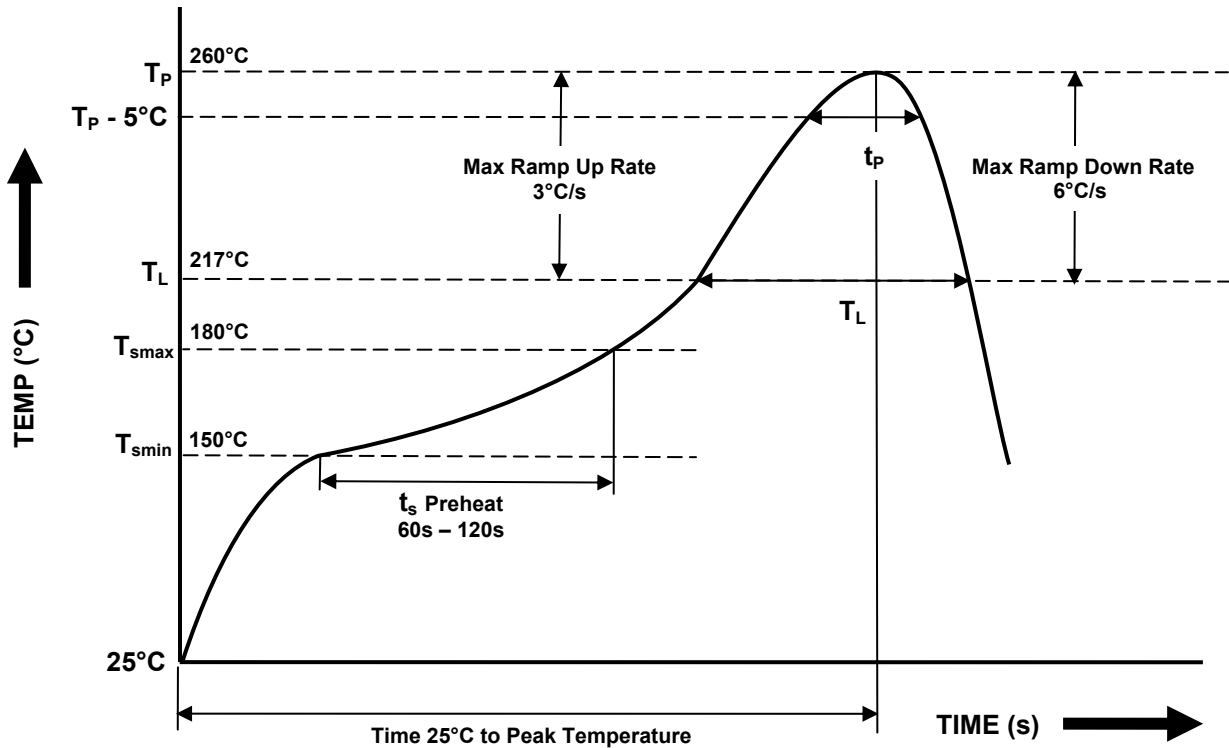
Direction of feed from reel



Dimension No.	<b>A0</b>	<b>B0</b>	<b>D0</b>	<b>D1</b>	<b>E</b>	<b>F</b>
Dimension( mm)	3.00±0.10	7.45±0.10	1.50+0.1/-0	1.50±0.10	1.75±0.10	5.5±0.10
Dimension No.	<b>P0</b>	<b>P1</b>	<b>P2</b>	<b>t</b>	<b>W</b>	<b>K0</b>
Dimension (mm)	4.00±0.15	4.00±0.10	2.00±0.10	0.30±0.05	12.1±0.2	2.45±0.1

**IR REFLOW SOLDERING TEMPERATURE PROFILE**

One Time Reflow Soldering is Recommended.  
Do not immerse device body in solder paste.



Profile Details	Conditions
<b>Preheat</b> - Min Temperature (T <sub>SMIN</sub> ) - Max Temperature (T <sub>SMAX</sub> ) - Time T <sub>SMIN</sub> to T <sub>SMAX</sub> (t <sub>s</sub> )	150°C 180°C 60s - 120s
<b>Soldering Zone</b> - Peak Temperature (T <sub>P</sub> ) - Liquidous Temperature (T <sub>L</sub> ) - Time within 5°C of Actual Peak Temperature (T <sub>P</sub> - 5°C) - Time maintained above T <sub>L</sub> (t <sub>L</sub> ) - Ramp Up Rate (T <sub>L</sub> to T <sub>P</sub> ) - Ramp Down Rate (T <sub>P</sub> to T <sub>L</sub> )	260°C 217°C 20s 60s 3°C/s max 3 - 6°C/s
Average Ramp Up Rate (T <sub>smax</sub> to T <sub>P</sub> )	3°C/s max
Time 25°C to Peak Temperature	8 minutes max



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